

N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

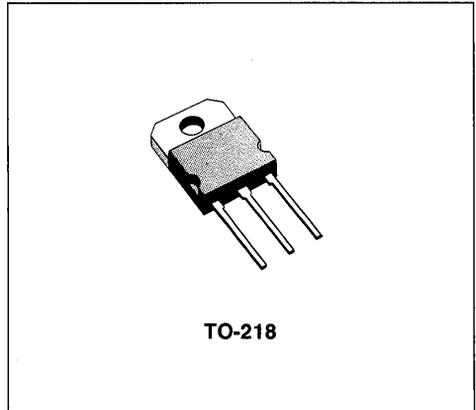
TYPE	V _{DSS}	R _{DS(on)}	I _D
SGSP471	100 V	0.075 Ω	30 A
SGSP472	80 V	0.05 Ω	35 A

- HIGH SPEED SWITCHING APPLICATIONS
- 80 - 100 VOLTS - FOR DC/DC CONVERTERS
- HIGH CURRENT > 1V DROP AT 20A
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- ULTRA FAST SWITCHING
- EASY DRIVE FOR REDUCED SIZE AND COST

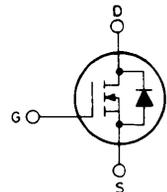
INDUSTRIAL APPLICATIONS:

- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistors. Easy drive and very fast switching times make these POWER MOS transistors ideal for high speed switching applications. Applications include DC/DC converters, UPS, battery chargers, secondary regulators, servo control, power audio amplifiers and robotics.



INTERNAL SCHEMATIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

	SGSP471	SGSP472	
V _{DS}	100	80	V
V _{DGR}	100	80	V
V _{GS}		±20	V
I _D	30	35	A
I _D	19	22	A
I _{DM} (*)	120	140	A
P _{tot}		150	W
		1.2	W/°C
T _{stg}	-65 to 150		°C
T _j	150		°C

(*) Pulse width limited by safe operating area
 ♦ Introduced in 1988 week 44

THERMAL DATA

$R_{thj - case}$	Thermal resistance junction-case	max	0.83	°C/W
T_L	Maximum lead temperature for soldering purpose		275	°C

ELECTRICAL CHARACTERISTICS ($T_{case} = 25^{\circ}C$ unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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OFF

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu A$ for SGSP471 for SGSP472	$V_{GS} = 0$	100 80		V V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$	$T_c = 125^{\circ}C$		250 1000	μA μA
I_{GSS}	Gate-body leakage current ($V_{DS} = 0$)	$V_{GS} = \pm 20 V$			± 100	nA

ON (*)

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu A$	2		4	V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 V$ $I_D = 15 A$ for SGSP471 $I_D = 17.5 A$ for SGSP472 $V_{GS} = 10 V$ $I_D = 15 A$ for SGSP471 $I_D = 17.5 A$ for SGSP472	$T_c = 100^{\circ}C$			0.075 0.05 0.15 0.1	Ω Ω Ω Ω

ENERGY TEST

I_{UIS}	Unclamped inductive switching current (single pulse)	$V_{DD} = 30 V$ starting $T_j = 25^{\circ}C$ for SGSP471 for SGSP472	$L = 100 \mu H$	30 35			A A
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DYNAMIC

g_{fs}	Forward transconductance	$V_{DS} = 25 V$	$I_D = 17.5 A$	9			mho
C_{iss}	Input capacitance	$V_{DS} = 25 V$	$f = 1 MHz$		1800	2200	pF
C_{oss}	Output capacitance	$V_{GS} = 0$				810	pF
C_{rss}	Reverse transfer capacitance					375	pF

ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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SWITCHING

$t_{d(on)}$	Turn-on time	$V_{DD} = 50\text{ V}$ $I_D = 17.5\text{ A}$ $V_i = 10\text{ V}$ $R_i = 4.7\ \Omega$ (see test circuit)		30	40	ns
t_r	Rise time			85	110	ns
$t_{d(off)}$	Turn-off delay time			100	130	ns
t_f	Fall time			40	55	ns

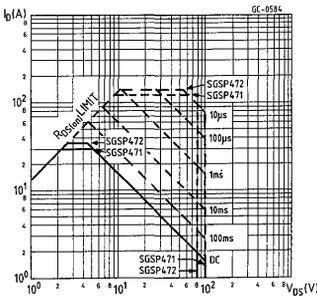
SOURCE DRAIN DIODE

I_{SD}	Source-drain current	for SGSP471 for SGSP472			30	A
$I_{SDM} (*)$	Source-drain current (pulsed)	for SGSP471 for SGSP472			35 120 140	A A A
V_{SD}	Forward on voltage	$V_{GS} = 0$ $I_{SD} = 30\text{ A}$ for SGSP471 $I_{SD} = 35\text{ A}$ for SGSP472			1.35 1.35	V V
t_{rr}	Reverse recovery time	$I_{SD} = 35\text{ A}$ $V_{GS} = 0$ $di/dt = 25\text{ A}/\mu\text{s}$		190		ns

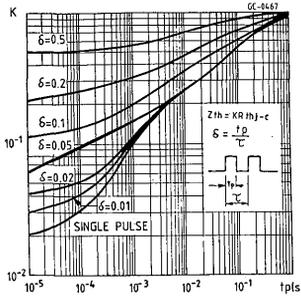
(*) Pulsed: Pulse duration = 300 μs , duty cycle 1.5%

(*) Pulse width limited by safe operating area

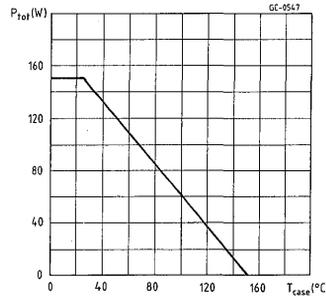
Safe operating areas



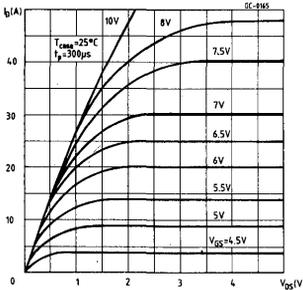
Thermal impedance



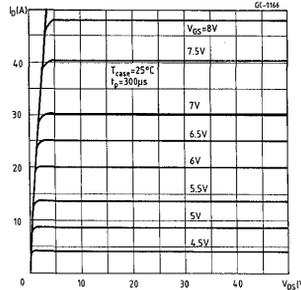
Derating curve



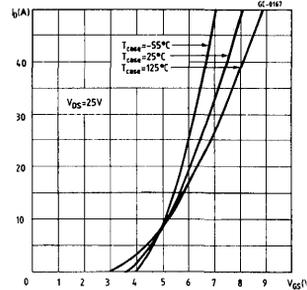
Output characteristics



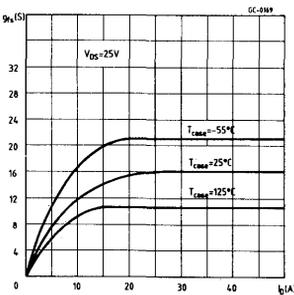
Output characteristics



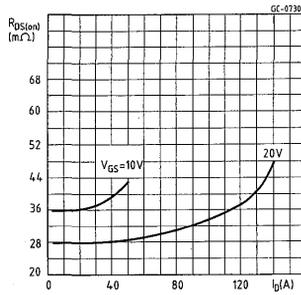
Transfer characteristics



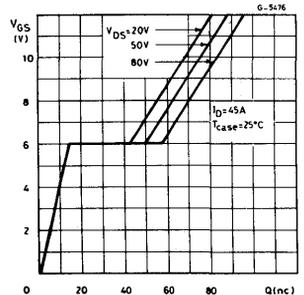
Transconductance



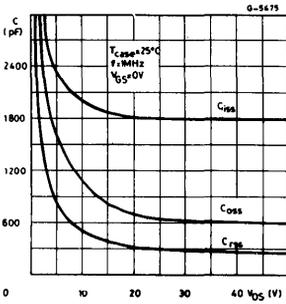
Static drain-source on resistance



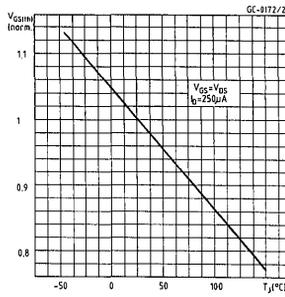
Gate charge vs gate-source voltage



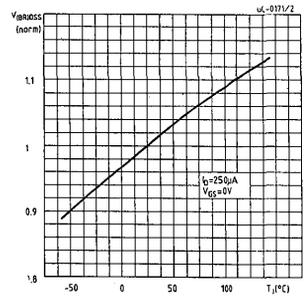
Capacitance variation



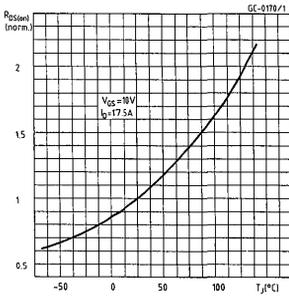
Normalized gate threshold voltage vs temperature



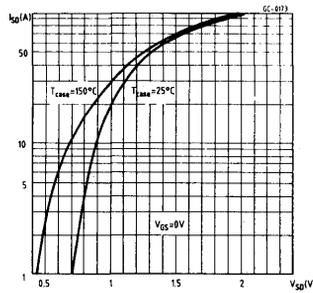
Normalized breakdown voltage vs temperature



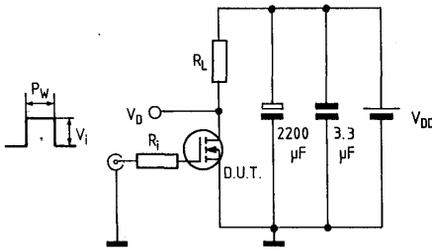
Normalized on resistance vs temperature



Source-drain diode forward characteristics



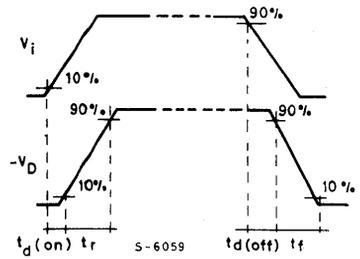
Switching times test circuit for resistive load



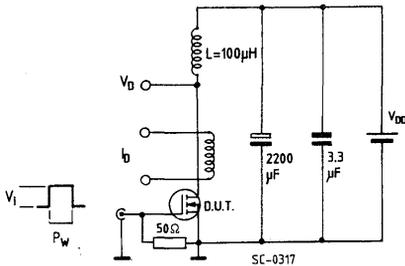
Pulse width $\leq 100 \mu\text{s}$
 Duty cycle $\leq 2\%$

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Switching time waveforms for resistive load



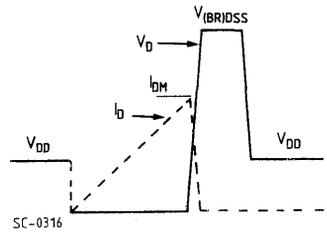
Unclamped inductive load test circuit



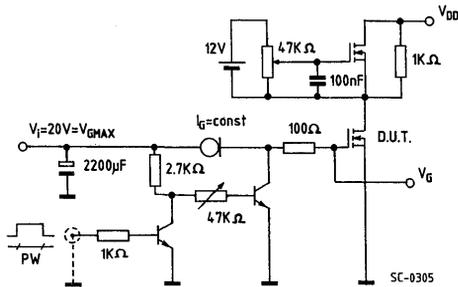
$V_i = 12 \text{ V}$ - Pulse width: adjusted to obtain specified I_{DM}

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Unclamped inductive waveforms



Gate charge test circuit



PW adjusted to obtain required V_G

SC-0305

Body-drain diode t_{rr} measurement
 Jedec test circuit

